RESPONSE UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE GROUP ART UNIT 1795

Docket Number 36856.1455

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hiroyuki KANBARA et al.

	I Art Unit: 1795
Application No.: 10/596,000	, at 5.ma 1.55
Confirmation No.: 1561	Examiner: A. Eoff
Filing or 371(c) Date: January 17, 2007	
Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	
AMENDMENT	
Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450	
Sir:	
In response to the Office Action dated April 2, 2008, please amend the above-	
identified application as follows:	
Amendments to the Specification begin on page of this paper.	
Amendments to the Claims are reflected in the listing of the claims which	
begins on page 2 of this paper.	
☐ Amendments to the Drawings begin on page of this paper and include an	
attached replacement sheet. An Appendix including the amended drawing figures is	
attached following page of this paper.	
Remarks/Arguments begin on page 6 of this paper.	
Please note, if a box is not checked, then no corresponding amendment is being made.	